# 74LV153

# Dual 4-input multiplexer Rev. 5 — 12 December 2011

**Product data sheet** 

#### **General description** 1.

The 74LV153 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC153 and 74HCT153.

The 74LV153 provides a dual 4-input multiplexer which selects 2 bits of data from up to four sources selected by common data select inputs (S0, S1). The two 4-input multiplexer circuits have individual active LOW output enable inputs (1E, 2E) which can be used to strobe the outputs independently. The outputs (1Y, 2Y) are forced LOW when the corresponding output enable inputs are HIGH. The 74LV153 is the logic implementation of a 2-pole, 4-position switch, where the position of the switch, is determined by the logic levels applied to S0 and S1. The logic equations for the outputs are:

$$1Y = 1\overline{E} \times (110 \times \overline{S1} \times \overline{S0} + 111 \times \overline{S1} \times S0 + 112 \times S1 \times \overline{S0} + 113 \times S1 \times S0)$$

$$2Y = 2\overline{E} \times (210 \times \overline{S1} \times \overline{S0} + 211 \times \overline{S1} \times S0 + 212 \times S1 \times \overline{S0} + 213 \times S1 \times S0)$$

The 74LV153 can be used to move data to a common output bus from a group of registers. The state of the select inputs would determine the particular register from which the data came. An alternative application is a function generator. The device can generate two functions or three variables. This is useful for implementing highly irregular random logic.

#### **Features and benefits** 2.

- Wide operating voltage: 1.0 V to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Typical output ground bounce < 0.8 V at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C
- Typical HIGH-level output voltage (V<sub>OH</sub>) undershoot: > 2 V at V<sub>CC</sub> = 3.3 V and  $T_{amb} = 25 \, ^{\circ}C$
- Non-inverting outputs
- Separate enable input for each output
- Common select inputs
- Permits multiplexing from n lines to 1 line
- Enable line provided for cascading (n lines to 1 line)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



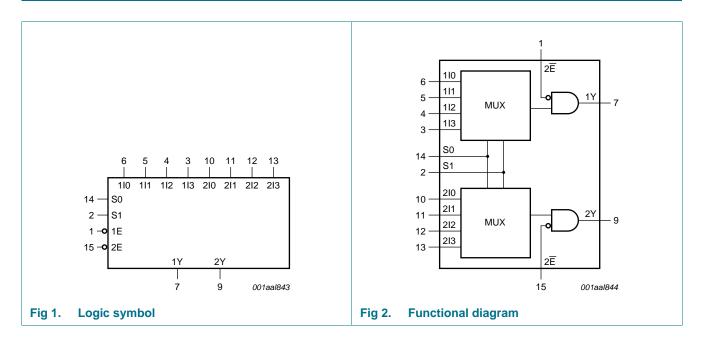
**Dual 4-input multiplexer** 

### 3. Ordering information

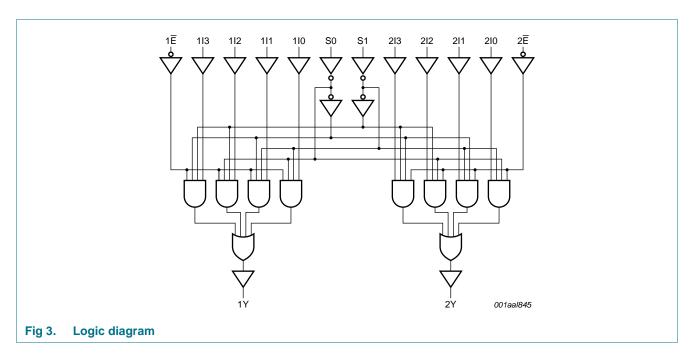
Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74LV153N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4					
74LV153D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LV153DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74LV153PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

## 4. Functional diagram

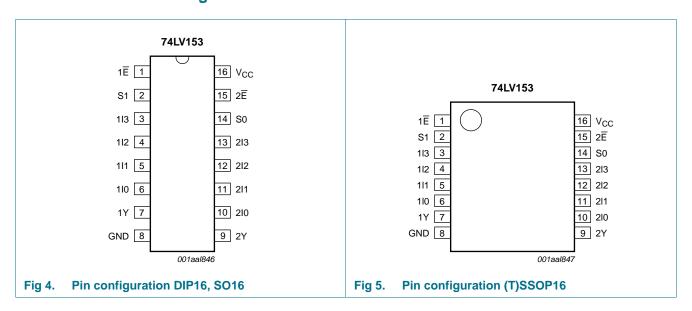


#### **Dual 4-input multiplexer**



### 5. Pinning information

### 5.1 Pinning



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### **Dual 4-input multiplexer**

### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1E, 2E	1, 15	output enable inputs (active LOW)
S0, S1	14, 2	data select inputs
110, 111, 112, 113	6, 5, 4, 3	data inputs source 1
1Y	7	multiplexer output source 1
GND	8	ground (0 V)
2Y	9	multiplexer output source 2
210, 211, 212, 213	10, 11, 12, 13	data inputs source 2
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

select Inp	uts	data inpi	uts	output enable	output		
S0	<b>S</b> 1	nI0	nl1	nl2	nl3	nE	nY
Χ	Χ	X	X	X	X	Н	L
L	L	L	Χ	X	X	L	L
L	L	Н	Χ	Х	Χ	L	Н
Н	L	X	L	Х	Χ	L	L
Н	L	X	Н	Х	Χ	L	Н
L	Н	X	Χ	L	Χ	L	L
L	Н	X	Χ	Н	Χ	L	Н
Н	Н	X	Χ	Х	L	L	L
Н	Н	X	Χ	X	Н	L	Н

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	<u>[1]</u> -	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$	<u>[1]</u> -	±50	mA
I <sub>O</sub>	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C

#### **Dual 4-input multiplexer**

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$P_{tot}$	$T_{tot}$ total power dissipation $T_{amb} = -40  ^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$				
	DIP16 package		[2] -	750	mW
	SO16 package		[3] _	500	mW
	(T)SSOP16 package		<u>[4]</u> -	500	mW

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- [2]  $P_{tot}$  derates linearly with 12 mW/K above 70 °C.
- [3]  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.
- [4]  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		<u>[1]</u> 1.0	3.3	3.6	V
VI	input voltage		0	-	$V_{CC}$	V
Vo	output voltage		0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 1.0 \text{ V to } 2.0 \text{ V}$	-	-	500	ns/V
		$V_{CC} = 2.0 \text{ V to } 2.7 \text{ V}$	-	-	200	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	100	ns/V

<sup>[1]</sup> The static characteristics are guaranteed from  $V_{CC}$  = 1.2 V to  $V_{CC}$  = 5.5 V, but LV devices are guaranteed to function down to  $V_{CC}$  = 1.0 V (with input levels GND or  $V_{CC}$ ).

**Dual 4-input multiplexer** 

### 9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 1.2 V	0.9	- '	-	0.9	-	V
		V <sub>CC</sub> = 2.0 V	1.4	-	-	1.4	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	0.3	-	0.3	V
		V <sub>CC</sub> = 2.0 V	-	-	0.6	-	0.6	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$						
		$I_{O} = -100 \mu A; V_{CC} = 1.2 V$	-	1.2	-	-	-	V
		$I_O = -100 \mu A; V_{CC} = 2.0 V$	1.8	2.0	-	1.8	-	V
		$I_O = -100 \mu A; V_{CC} = 2.7 V$	2.5	2.7	-	2.5	-	V
		$I_O = -100 \mu A; V_{CC} = 3.0 V$	2.8	3.0	-	2.8	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	2.82	-	2.2	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$						
		$I_O = 100 \mu A; V_{CC} = 1.2 V$	-	0	-	-	-	V
		$I_O = 100 \mu A; V_{CC} = 2.0 V$	-	0	0.2	-	0.2	V
		$I_O = 100 \mu A; V_{CC} = 2.7 V$	-	0	0.2	-	0.2	V
		$I_O = 100 \mu A; V_{CC} = 3.0 V$	-	0	0.2	-	0.2	V
		$I_O = 6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.25	0.40	-	0.50	V
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$	-	-	1.0	-	1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6 \text{ V}$	-	-	20.0	-	160	μΑ
$\Delta I_{CC}$	additional supply current	per input; $V_I = V_{CC} - 0.6 \text{ V}$ ; $V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	-	500	-	850	μΑ
Cı	input capacitance		-	3.5	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

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### 10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +85	S °C	–40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	1In to 1Y and 2In to 2Y; see Figure 6	[2]						
		V <sub>CC</sub> = 1.2 V		-	85	-	-	-	ns
		V <sub>CC</sub> = 2.0 V		-	29	56	-	66	ns
		$V_{CC} = 2.7 \text{ V}$		-	21	41	-	49	ns
		$V_{CC} = 3.3 \text{ V}; C_L = 15 \text{ pF}$		-	14	-	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	<u>[3]</u>	-	16	33	-	39	ns
		Sn to nY; see Figure 6							
		$V_{CC}$ = 1.2 V		-	90	-	-	-	ns
		$V_{CC} = 2.0 \text{ V}$		-	31	58	-	70	ns
		$V_{CC} = 2.7 V$		-	23	43	-	51	ns
		$V_{CC} = 3.3 \text{ V}; C_L = 15 \text{ pF}$		-	14	-	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	<u>[3]</u>	-	17	34	-	41	ns
		nE to nY; see Figure 6							
		$V_{CC}$ = 1.2 V		-	60	-	-	-	ns
		$V_{CC} = 2.0 \text{ V}$		-	20	39	-	46	ns
		$V_{CC} = 2.7 V$		-	15	29	-	34	ns
		$V_{CC} = 3.3 \text{ V}; C_L = 15 \text{ pF}$		-	10	-	-	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	<u>[3]</u>	-	11	23	-	27	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	<u>[4]</u>	-	30	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

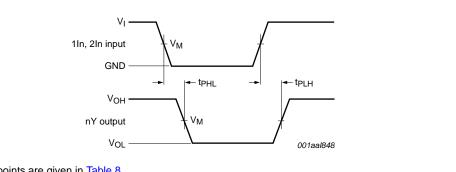
<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

<sup>[3]</sup> Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V) unless otherwise stated.

<sup>[4]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

**Dual 4-input multiplexer** 

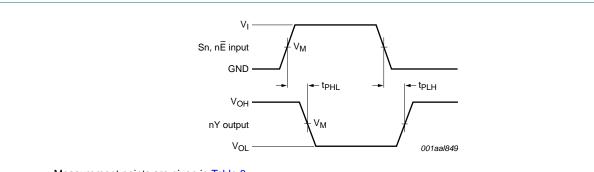
### 11. Waveforms



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

Fig 6. The input (1In, 2In) to output (1Y, 2Y) propagation delays



Measurement points are given in  $\underline{\text{Table 8}}$ .

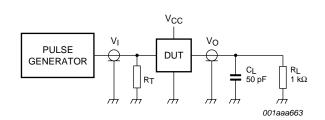
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig 7. The input (Sn, nE) to output (nY) propagation delays

Table 8. Measurement points

Supply voltage	Input	Output		
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>		
< 2.7 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>		
2.7 V to 3.6 V	1.5 V	1.5 V		

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Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

Fig 8. Test circuit for measuring switching times

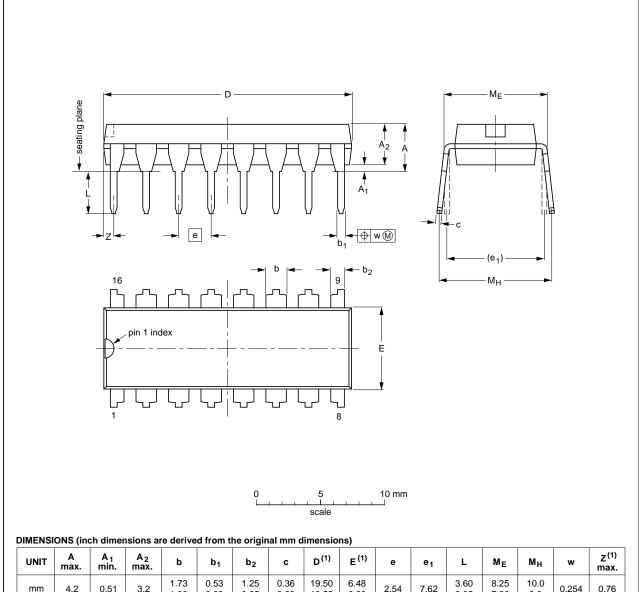
Table 9. Test data

Supply voltage	Input	
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>
< 2.7 V	V <sub>CC</sub>	≤ 2.5 ns
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns

### 12. Package outline

#### DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	C	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

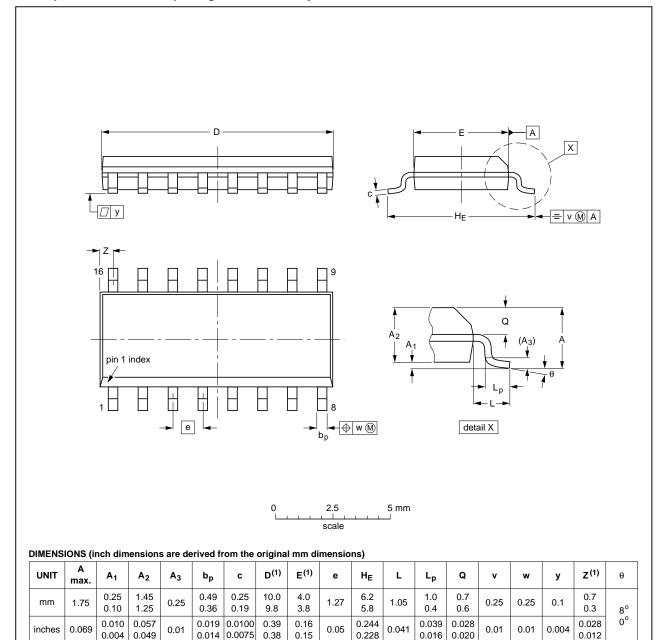
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT38-4						<del>95-01-14</del> 03-02-13	

Fig 9. Package outline SOT38-4 (DIP16)

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

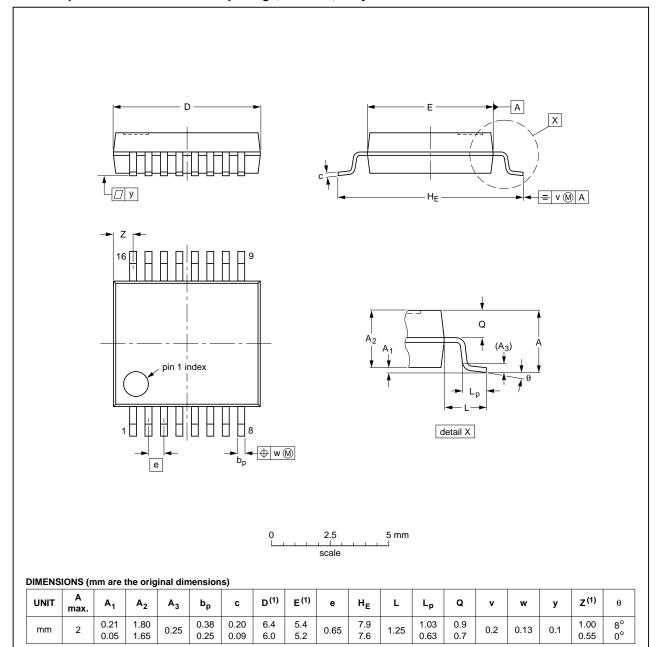
OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig 10. Package outline SOT109-1 (SO16)

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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

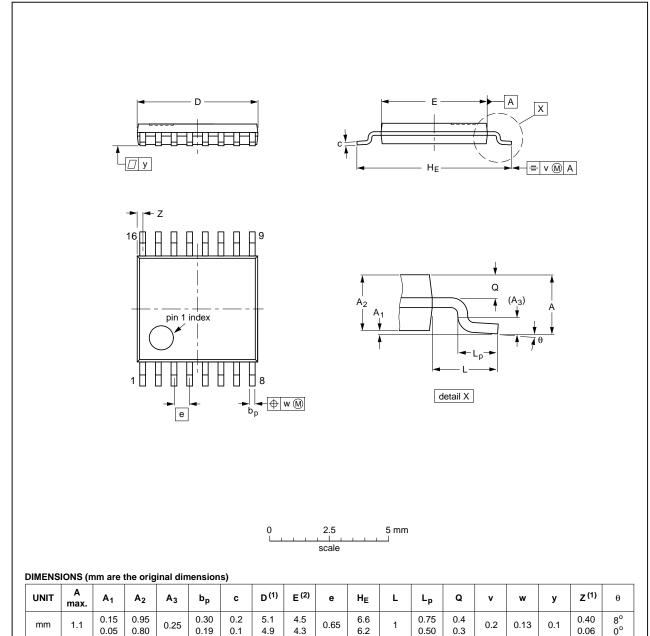
OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT338-1		MO-150				<del>99-12-27</del> 03-02-19

Fig 11. Package outline SOT338-1 (SSOP16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFERENCES				ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig 12. Package outline SOT403-1 (TSSOP16)

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**Dual 4-input multiplexer** 

### 13. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV153 v.5	20111212	Product data sheet	-	74LV153 v.4
Modifications:	<ul> <li>Legal pages upo</li> </ul>	lated.		
74LV153 v.4	20100429	Product data sheet	-	74LV153 v.3
74LV153 v.3	19980428	Product specification	-	74LV153 v.2
74LV153 v.2	19970515	Product specification	-	-

**Dual 4-input multiplexer** 

### 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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#### **Dual 4-input multiplexer**

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### **Dual 4-input multiplexer**

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